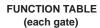
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 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

These devices contain four independent 2-input positive-OR <u>gates</u>. They perform the Boolean functions $Y = \overline{A} \bullet \overline{B}$ or Y = A + B in positive logic.

The SN54ALS32 and SN54AS32 are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS32 and SN74AS32 are characterized for operation from 0°C to 70°C.



INP	UTS	OUTPUT					
Α	В	Y					
Н	Х	Н					
х	Н	н					
L	L	L					

logic symbol[†]

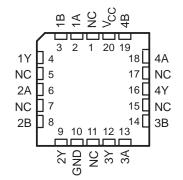
1A	1	≥1	3	
	2	<u> </u>	3	1Y
	4			
2A	5		6	2Y
28	9			
1B 2A 2B 3A 3B 4A 4B	10		8	3Y
38	12			
4A	13		11	4Y
4B				

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

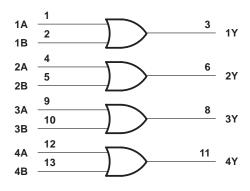
SN54ALS32, SN54AS32 J PACKAGE SN74ALS32, SN74AS32 D OR N PACKAGE (TOP VIEW)										
1A 1B 1Y 2A 2B 2Y GND	1 2 4 5 6 7	14 13 12 11 10 9 8	V _{CC} 4B 4A 4Y 3B 3A 3Y							

SN54ALS32, SN54AS32 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Input voltage, V ₁	
Operating free-air temperature range, T _A : SN54ALS32	
SN74ALS32	0°C to 70°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN	154ALS3	32	SN74ALS32		UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-0.4			-0.4	mA
IOL	Low-level output current			4			8	mA
ТА	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST	ONDITIONS	SM	154ALS3	32	SN	174ALS3	2	UNIT
PARAMETER	TEST C	UNDITIONS	MIN	TYP‡	MAX	MIN	typ‡	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lj = -18 mA			-1.5			-1.5	V
VOH	V_{CC} = 4.5 V to 5.5 V,	I _{OH} = -0.4 mA	V _{CC} -2	2		V _{CC} -2	2		V
Ve	V_{OI} $V_{CC} = 4.5 V$	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	V
VOL		I _{OL} = 8 mA					0.35	0.5	v
lı	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
ΙIΗ	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μA
١	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA
١ _O §	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
ІССН	V _{CC} = 5.5 V,	V _I = 4.5 V		1.9	4		1.9	4	mA
ICCL	V _{CC} = 5.5 V,	V _I = 0		2.6	4.9		2.6	4.9	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

\$ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX¶ SN54ALS32 SN74ALS32		CL = 50 pF, RL = 500 Ω, T _A = MIN to MAX¶			
			MIN	MAX	MIN	MAX		
^t PLH	A or B	v	3	18	3	14		
^t PHL	AUD	Y	3	16	3	12	ns	

 \P For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Input voltage, V ₁	
Operating free-air temperature range, T _A : SN54AS32	
SN74AS32	0°C to 70°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS32		S	UNIT			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-2			-2	mA
IOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TERTO	ONDITIONS	SI	V54AS 3	2	S	N74AS3	2	UNIT
PARAMETER	TESTO	UNDITIONS	MIN	typ‡	MAX	MIN	typ‡	MAX	UNIT
VIK	V _{CC} = 4.5 V,	l _l = -18 mA			-1.2			-1.2	V
VOH	V _{CC} = 4.5 V to 5.5 V,	$I_{OH} = -2 \text{ mA}$	V _{CC} -2			V _{CC} -2	2		V
V _{OL}	$V_{CC} = 4.5 V,$	I _{OL} = 20 mA		0.35	0.5		0.35	0.5	V
l	V _{CC} = 5.5 V,	$V_{I} = 7 V$			0.1			0.1	mA
IIН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ
١ _{IL}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.5			-0.5	mA
ΙΟ§	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30		-112	mA
ICCH	V _{CC} = 5.5 V,	V _I = 4.5 V		7.3	12		7.3	12	mA
ICCL	V _{CC} = 5.5 V,	$V_{I} = 0$		16.5	26.6		16.5	26.6	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

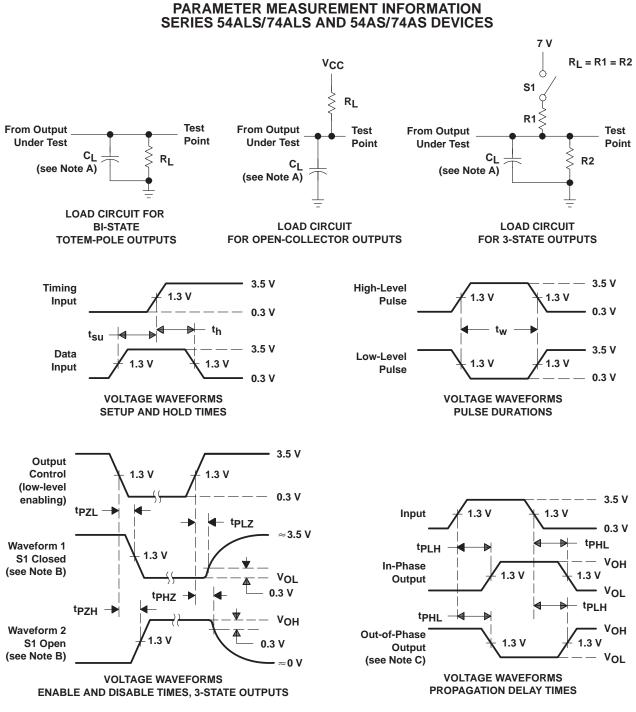
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX [¶] SN54AS32 SN74AS32		C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX¶		
			MIN	MAX	MIN	MAX	
^t PLH	A or B	V	1	7.5	1	5.8	ns
^t PHL	AOIB	Y Y	1	6.5	1	5.8	115

 \P For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open. D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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